

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Paul Robert Hoffman and David Albert Zoba  
Assignee: Amkor Technology, Inc.  
Title: Structures For Improving Heat Dissipation In  
Stacked Semiconductor Packages  
Serial No.: Not Yet Assigned File Date: Herewith  
Examiner: Not Yet Assigned Art Unit: Not Yet Assigned  
Docket No.: AMK-11317-1D

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Date: February 2, 2004

Mail Stop Patent Application  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

PRELIMINARY AMENDMENT

Dear Sir:

Prior to assessing the filing fee, and prior to examining  
the application, please amend the application as follows.